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Intel - 5SGXEA4K2F40I2LN Datasheet



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Understanding <u>Embedded - FPGAs (Field</u> <u>Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

| Product Status | Obsolete |
|--------------------------------|---|
| Number of LABs/CLBs | 158500 |
| Number of Logic Elements/Cells | 420000 |
| Total RAM Bits | 37888000 |
| Number of I/O | 696 |
| Number of Gates | - |
| Voltage - Supply | 0.82V ~ 0.88V |
| Mounting Type | Surface Mount |
| Operating Temperature | -40°C ~ 100°C (TJ) |
| Package / Case | 1517-BBGA, FCBGA |
| Supplier Device Package | 1517-FBGA (40x40) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/5sgxea4k2f40i2ln |
| | |

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Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

| Symbol | Description | Condition | Min ⁽⁴⁾ | Тур | Max ⁽⁴⁾ | Unit |
|--------|------------------------|--------------|--------------------|-----|--------------------|------|
| + | Power supply ramp time | Standard POR | 200 µs | _ | 100 ms | — |
| LRAMP | Power supply ramp time | Fast POR | 200 µs | | 4 ms | _ |

Table 6. Recommended Operating Conditions for Stratix V Devices (Part 2 of 2)

Notes to Table 6:

(1) V_{CCPD} must be 2.5 V when V_{CCI0} is 2.5, 1.8, 1.5, 1.35, 1.25 or 1.2 V. V_{CCPD} must be 3.0 V when V_{CCI0} is 3.0 V.

(2) If you do not use the design security feature in Stratix V devices, connect V_{CCBAT} to a 1.2- to 3.0-V power supply. Stratix V power-on-reset (POR) circuitry monitors V_{CCBAT}. Stratix V devices will not exit POR if V_{CCBAT} stays at logic low.

(3) C2L and I2L can also be run at 0.90 V for legacy boards that were designed for the C2 and I2 speed grades.

(4) The power supply value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

Table 7 lists the transceiver power supply recommended operating conditions for Stratix V GX, GS, and GT devices.

Table 7. Recommended Transceiver Power Supply Operating Conditions for Stratix V GX, GS, and GT Devices (Part 1 of 2)

| Symbol | Description | Devices | Minimum ⁽⁴⁾ | Typical | Maximum ⁽⁴⁾ | Unit |
|-----------------------|---|------------|------------------------|---------|------------------------|------|
| V _{CCA_GXBL} | Transceiver channel PLL power supply (left | GX, GS, GT | 2.85 | 3.0 | 3.15 | V |
| (1), (3) | side) | un, uo, ui | 2.375 | 2.5 | 2.625 | v |
| V _{CCA_GXBR} | Transceiver channel PLL power supply (right | GX, GS | 2.85 | 3.0 | 3.15 | V |
| (1), (3) | side) | ux, us | 2.375 | 2.5 | 2.625 | v |
| V _{CCA_GTBR} | Transceiver channel PLL power supply (right side) | GT | 2.85 | 3.0 | 3.15 | V |
| | Transceiver hard IP power supply (left side; C1, C2, I2, and I3YY speed grades) | GX, GS, GT | 0.87 | 0.9 | 0.93 | V |
| V _{CCHIP_L} | Transceiver hard IP power supply (left side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades) | GX, GS, GT | 0.82 | 0.85 | 0.88 | V |
| | Transceiver hard IP power supply (right side; C1, C2, I2, and I3YY speed grades) | GX, GS, GT | 0.87 | 0.9 | 0.93 | V |
| V _{CCHIP_R} | Transceiver hard IP power supply (right side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades) | GX, GS, GT | 0.82 | 0.85 | 0.88 | V |
| | Transceiver PCS power supply (left side; C1, C2, I2, and I3YY speed grades) | GX, GS, GT | 0.87 | 0.9 | 0.93 | V |
| V _{CCHSSI_L} | Transceiver PCS power supply (left side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades) | GX, GS, GT | 0.82 | 0.85 | 0.88 | V |
| | Transceiver PCS power supply (right side; C1, C2, I2, and I3YY speed grades) | GX, GS, GT | 0.87 | 0.9 | 0.93 | V |
| V _{CCHSSI_R} | Transceiver PCS power supply (right side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades) | GX, GS, GT | 0.82 | 0.85 | 0.88 | V |
| | | | 0.82 | 0.85 | 0.88 | |
| V _{CCR_GXBL} | Pacaivar analog powar supply (left side) | GX, GS, GT | 0.87 | 0.90 | 0.93 | V |
| (2) | Receiver analog power supply (left side) | un, uo, ui | 0.97 | 1.0 | 1.03 | v |
| | | | 1.03 | 1.05 | 1.07 | |

Table 8 shows the transceiver power supply voltage requirements for various conditions.

Table 8. Transceiver Power Supply Voltage Requirements

| Conditions | Core Speed Grade | VCCR_GXB & VCCT_GXB ⁽²⁾ | VCCA_GXB | VCCH_GXB | Unit |
|---|-----------------------------------|---------------------------------------|----------|----------|------|
| If BOTH of the following conditions are true: | All | 1.05 | | | |
| Data rate > 10.3 Gbps. DFE is used. | All | 1.05 | | | |
| If ANY of the following conditions are true ⁽¹⁾ : | | | 3.0 | | |
| ATX PLL is used. | | | | | |
| ■ Data rate > 6.5Gbps. | All | 1.0 | | | |
| ■ DFE (data rate ≤ 10.3 Gbps), AEQ, or EyeQ feature is used. | | | | 1.5 | V |
| If ALL of the following | C1, C2, I2, and I3YY | 0.90 | 2.5 | | |
| conditions are true:ATX PLL is not used. | | | | | |
| ■ Data rate ≤ 6.5Gbps. | C2L, C3, C4, I2L, I3, I3L, and I4 | 0.85 | 2.5 | | |
| DFE, AEQ, and EyeQ are not used. | | | | | |

Notes to Table 8:

(1) Choose this power supply voltage requirement option if you plan to upgrade your design later with any of the listed conditions.

(2) If the VCCR_GXB and VCCT_GXB supplies are set to 1.0 V or 1.05 V, they cannot be shared with the VCC core supply. If the VCCR_GXB and VCCT_GXB are set to either 0.90 V or 0.85 V, they can be shared with the VCC core supply.

DC Characteristics

This section lists the supply current, I/O pin leakage current, input pin capacitance, on-chip termination tolerance, and hot socketing specifications.

Supply Current

Supply current is the current drawn from the respective power rails used for power budgeting. Use the Excel-based Early Power Estimator (EPE) to get supply current estimates for your design because these currents vary greatly with the resources you use.

For more information about power estimation tools, refer to the *PowerPlay Early Power Estimator User Guide* and the *PowerPlay Power Analysis* chapter in the *Quartus II Handbook*.

I/O Pin Leakage Current

Table 9 lists the Stratix V I/O pin leakage current specifications.

| Table 9. I/ | 0 Pin Leakage | Current for Stratix | / Devices ⁽¹⁾ |
|-------------|---------------|-----------------------------|--------------------------|
|-------------|---------------|-----------------------------|--------------------------|

| Symbol | Description | Conditions | Min | Тур | Max | Unit |
|-----------------|--------------------|--|-----|-----|-----|------|
| I _I | Input pin | $V_I = 0 V \text{ to } V_{CCIOMAX}$ | -30 | — | 30 | μA |
| I _{0Z} | Tri-stated I/O pin | $V_0 = 0 V \text{ to } V_{\text{CCIOMAX}}$ | -30 | | 30 | μA |

Note to Table 9:

(1) If $V_0 = V_{CCIO}$ to $V_{CCIOMax}$, 100 μ A of leakage current per I/O is expected.

Bus Hold Specifications

Table 10 lists the Stratix V device family bus hold specifications.

Table 10. Bus Hold Parameters for Stratix V Devices

| | | | | V _{CCI0} | | | | | | | | | |
|-------------------------------|-------------------|--|-------|-------------------|-------|------|-------|------|-------|------|-------|------|------|
| Parameter | Symbol | Conditions | 1.2 | 2 V | 1. | 5 V | 1.8 | B V | 2. | 5 V | 3.0 | V | Unit |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | Min | Max | |
| Low sustaining current | I _{SUSL} | V _{IN} > V _{IL} (maximum) | 22.5 | _ | 25.0 | _ | 30.0 | _ | 50.0 | _ | 70.0 | _ | μA |
| High sustaining current | I _{SUSH} | V _{IN} < V _{IH} (minimum) | -22.5 | _ | -25.0 | _ | -30.0 | _ | -50.0 | _ | -70.0 | _ | μA |
| Low overdrive current | I _{odl} | $0V < V_{IN} < V_{CCIO}$ | _ | 120 | _ | 160 | _ | 200 | _ | 300 | _ | 500 | μA |
| High overdrive current | I _{odh} | $0V < V_{IN} < V_{CCIO}$ | | -120 | | -160 | _ | -200 | | -300 | _ | -500 | μA |
| Bus-hold trip point | V _{trip} | _ | 0.45 | 0.95 | 0.50 | 1.00 | 0.68 | 1.07 | 0.70 | 1.70 | 0.80 | 2.00 | V |

On-Chip Termination (OCT) Specifications

If you enable OCT calibration, calibration is automatically performed at power-up for I/Os connected to the calibration block. Table 11 lists the Stratix V OCT termination calibration accuracy specifications.

Table 11. OCT Calibration Accuracy Specifications for Stratix V Devices ⁽¹⁾ (Part 1 of 2)

| | | | | Calibratio | n Accuracy | | |
|---------------------|---|--|-----|------------|----------------|-------|------|
| Symbol | ymbol Description | | C1 | C2,12 | C3,I3, I3YY | C4,14 | Unit |
| 25-Ω R _S | Internal series termination with calibration (25- Ω setting) | V _{CCI0} = 3.0, 2.5, 1.8, 1.5, 1.2 V | ±15 | ±15 | ±15 | ±15 | % |

| Symbol | Description | V _{CCIO} (V) | Typical | Unit |
|--------|--|-----------------------|---------|------|
| | | 3.0 | 0.189 | |
| | | 2.5 | 0.208 | |
| dR/dT | OCT variation with temperature without recalibration | 1.8 | 0.266 | %/°C |
| | | 1.5 | 0.273 | |
| | | 1.2 | 0.317 | |

Table 13. OCT Variation after Power-Up Calibration for Stratix V Devices (Part 2 of 2)⁽¹⁾

Note to Table 13:

(1) Valid for a V_{CCIO} range of $\pm 5\%$ and a temperature range of 0° to 85°C.

Pin Capacitance

Table 14 lists the Stratix V device family pin capacitance.

Table 14. Pin Capacitance for Stratix V Devices

| Symbol | Value | Unit | |
|--------------------|--|------|----|
| C _{IOTB} | Input capacitance on the top and bottom I/O pins | 6 | pF |
| C _{IOLR} | Input capacitance on the left and right I/O pins | 6 | рF |
| C _{OUTFB} | Input capacitance on dual-purpose clock output and feedback pins | 6 | рF |

Hot Socketing

Table 15 lists the hot socketing specifications for Stratix V devices.

| Table 15. | Hot Socketing Specifications for Stratix V Devices |
|-----------|--|
|-----------|--|

| Symbol | Description | Maximum |
|---------------------------|--|---------------------|
| I _{IOPIN (DC)} | DC current per I/O pin | 300 μA |
| I _{IOPIN (AC)} | AC current per I/O pin | 8 mA ⁽¹⁾ |
| I _{XCVR-TX (DC)} | DC current per transceiver transmitter pin | 100 mA |
| I _{XCVR-RX (DC)} | DC current per transceiver receiver pin | 50 mA |

Note to Table 15:

(1) The I/O ramp rate is 10 ns or more. For ramp rates faster than 10 ns, $|I_{10PIN}| = C dv/dt$, in which C is the I/O pin capacitance and dv/dt is the slew rate.

Internal Weak Pull-Up Resistor

Table 16 lists the weak pull-up resistor values for Stratix V devices.

| Symbol | Description | V _{CCIO} Conditions (V) ⁽³⁾ | Value ⁽⁴⁾ | Unit |
|-----------------|---|--|----------------------|------|
| | | 3.0 ±5% | 25 | kΩ |
| | | 2.5 ±5% | 25 | kΩ |
| | Value of the I/O pin pull-up resistor before | 1.8 ±5% | 25 | kΩ |
| R _{PU} | and during configuration, as well as user mode if you enable the programmable | 1.5 ±5% | 25 | kΩ |
| | pull-up resistor option. | 1.35 ±5% | 25 | kΩ |
| | | 1.25 ±5% | 25 | kΩ |
| | | 1.2 ±5% | 25 | kΩ |

Table 16. Internal Weak Pull-Up Resistor for Stratix V Devices (1), (2)

Notes to Table 16:

(1) All I/O pins have an option to enable the weak pull-up resistor except the configuration, test, and JTAG pins.

(2) The internal weak pull-down feature is only available for the JTAG TCK pin. The typical value for this internal weak pull-down resistor is approximately 25 k Ω .

- (3) The pin pull-up resistance values may be lower if an external source drives the pin higher than V_{CCIO}.
- (4) These specifications are valid with a $\pm 10\%$ tolerance to cover changes over PVT.

I/O Standard Specifications

Table 17 through Table 22 list the input voltage (V_{IH} and V_{IL}), output voltage (V_{OH} and V_{OL}), and current drive characteristics (I_{OH} and I_{OL}) for various I/O standards supported by Stratix V devices. These tables also show the Stratix V device family I/O standard specifications. The V_{OL} and V_{OH} values are valid at the corresponding I_{OH} and I_{OL}, respectively.

For an explanation of the terms used in Table 17 through Table 22, refer to "Glossary" on page 65. For tolerance calculations across all SSTL and HSTL I/O standards, refer to Altera knowledge base solution rd07262012_486.

| I/O | | V _{ccio} (V) | | V | L (V) | VIH | (V) | V _{OL} (V) | V _{OH} (V) | IOL | I _{oh} |
|----------|-------|-----------------------|-------|------|-----------------------------|-----------------------------|-------------------------|-----------------------------|-----------------------------|------|-----------------|
| Standard | Min | Тур | Max | Min | Max | Min | Max | Max | Min | (mĀ) | (mÅ) |
| LVTTL | 2.85 | 3 | 3.15 | -0.3 | 0.8 | 1.7 | 3.6 | 0.4 | 2.4 | 2 | -2 |
| LVCMOS | 2.85 | 3 | 3.15 | -0.3 | 0.8 | 1.7 | 3.6 | 0.2 | $V_{CCI0} - 0.2$ | 0.1 | -0.1 |
| 2.5 V | 2.375 | 2.5 | 2.625 | -0.3 | 0.7 | 1.7 | 3.6 | 0.4 | 2 | 1 | -1 |
| 1.8 V | 1.71 | 1.8 | 1.89 | -0.3 | 0.35 * V _{CCI0} | 0.65 * V _{CCI0} | V _{CCI0} + 0.3 | 0.45 | V _{CCI0} – 0.45 | 2 | -2 |
| 1.5 V | 1.425 | 1.5 | 1.575 | -0.3 | 0.35 * V _{CCI0} | 0.65 * V _{CCI0} | V _{CCI0} + 0.3 | 0.25 * V _{CCI0} | 0.75 * V _{CCIO} | 2 | -2 |
| 1.2 V | 1.14 | 1.2 | 1.26 | -0.3 | 0.35 * V _{CCI0} | 0.65 * V _{CCIO} | V _{CCI0} + 0.3 | 0.25 * V _{CCI0} | 0.75 * V _{CCI0} | 2 | -2 |

Table 17. Single-Ended I/O Standards for Stratix V Devices

| I/O Standard | V _{IL(DI} | _{c)} (V) | V _{IH(D} | _{C)} (V) | V _{IL(AC)} (V) | V _{IH(AC)} (V) | V _{ol} (V) | V _{oh} (V) | I (mA) | I _{oh} |
|---------------------|--------------------|----------------------------|----------------------------|-----------------------------|----------------------------|-------------------------|----------------------------|----------------------------|----------------------|-----------------|
| i/U Stanuaru | Min | Max | Min | Max | Max | Min | Max | Min | l _{oi} (mA) | (mA) |
| HSTL-18 Class I | _ | V _{REF} – 0.1 | V _{REF} + 0.1 | _ | $V_{REF} - 0.2$ | V _{REF} + 0.2 | 0.4 | V _{CCIO} – 0.4 | 8 | -8 |
| HSTL-18 Class II | _ | V _{REF} – 0.1 | V _{REF} + 0.1 | _ | V _{REF} - 0.2 | V _{REF} + 0.2 | 0.4 | V _{CCIO} – 0.4 | 16 | -16 |
| HSTL-15 Class I | _ | V _{REF} – 0.1 | V _{REF} + 0.1 | _ | V _{REF} - 0.2 | V _{REF} + 0.2 | 0.4 | V _{CCIO} – 0.4 | 8 | -8 |
| HSTL-15 Class II | _ | V _{REF} – 0.1 | V _{REF} + 0.1 | _ | V _{REF} - 0.2 | V _{REF} + 0.2 | 0.4 | V _{CCIO} – 0.4 | 16 | -16 |
| HSTL-12 Class I | -0.15 | V _{REF} – 0.08 | V _{REF} + 0.08 | V _{CCIO} + 0.15 | V _{REF} – 0.15 | V _{REF} + 0.15 | 0.25* V _{CCI0} | 0.75* V _{CCI0} | 8 | -8 |
| HSTL-12 Class II | -0.15 | V _{REF} – 0.08 | V _{REF} + 0.08 | V _{CCIO} + 0.15 | V _{REF} – 0.15 | V _{REF} + 0.15 | 0.25* V _{CCIO} | 0.75* V _{CCI0} | 16 | -16 |
| HSUL-12 | _ | V _{REF} – 0.13 | V _{REF} + 0.13 | _ | V _{REF} – 0.22 | V _{REF} + 0.22 | 0.1* V _{CCIO} | 0.9* V _{CCI0} | _ | _ |

Table 19. Single-Ended SSTL, HSTL, and HSUL I/O Standards Signal Specifications for Stratix V Devices (Part 2 of 2)

Table 20. Differential SSTL I/O Standards for Stratix V Devices

| I/O Standard | | V _{ccio} (V) | | V _{SWIN} | _{G(DC)} (V) | | V _{X(AC)} (V) | | V _{swing(} , | _{AC)} (V) |
|-------------------------|-------|-----------------------|-------|-------------------|-------------------------|--------------------------------|------------------------|------------------------------|---|---|
| ijo Stanuaru | Min | Тур | Max | Min | Max | Min | Тур | Max | Min | Max |
| SSTL-2 Class I, II | 2.375 | 2.5 | 2.625 | 0.3 | V _{CCI0} + 0.6 | V _{CCI0} /2- 0.2 | _ | V _{CCI0} /2 + 0.2 | 0.62 | V _{CCI0} + 0.6 |
| SSTL-18 Class I, II | 1.71 | 1.8 | 1.89 | 0.25 | V _{CCI0} + 0.6 | V _{CCI0} /2- 0.175 | _ | V _{CCI0} /2 + 0.175 | 0.5 | V _{CCI0} + 0.6 |
| SSTL-15 Class I, II | 1.425 | 1.5 | 1.575 | 0.2 | (1) | V _{CCI0} /2- 0.15 | _ | V _{CCI0} /2 + 0.15 | 0.35 | _ |
| SSTL-135 Class I, II | 1.283 | 1.35 | 1.45 | 0.2 | (1) | V _{CCI0} /2- 0.15 | V _{CCI0} /2 | V _{CCI0} /2 + 0.15 | 2(V _{IH(AC)} - V _{REF}) | 2(V _{IL(AC)} - V _{REF}) |
| SSTL-125 Class I, II | 1.19 | 1.25 | 1.31 | 0.18 | (1) | V _{CCIO} /2- 0.15 | V _{CCI0} /2 | V _{CCI0} /2 + 0.15 | 2(V _{IH(AC)} - V _{REF}) | _ |
| SSTL-12 Class I, II | 1.14 | 1.2 | 1.26 | 0.18 | _ | V _{REF} -0.15 | V _{CCI0} /2 | V _{REF} + 0.15 | -0.30 | 0.30 |

Note to Table 20:

(1) The maximum value for $V_{SWING(DC)}$ is not defined. However, each single-ended signal needs to be within the respective single-ended limits $(V_{IH(DC)} \text{ and } V_{IL(DC)})$.

| I/O | | V _{ccio} (V) | | V _{DIF(DC)} (V) V _{X(AC)} (V) | | V _{CM(DC)} (V) | | | V _{DIF(AC)} (V) | | | | |
|------------------------|-------|-----------------------|-------|---|-----|-------------------------|-----|------|--------------------------|-----|------|-----|-----|
| Standard | Min | Тур | Max | Min | Max | Min | Тур | Max | Min | Тур | Max | Min | Max |
| HSTL-18 Class I, II | 1.71 | 1.8 | 1.89 | 0.2 | _ | 0.78 | _ | 1.12 | 0.78 | _ | 1.12 | 0.4 | _ |
| HSTL-15 Class I, II | 1.425 | 1.5 | 1.575 | 0.2 | _ | 0.68 | _ | 0.9 | 0.68 | _ | 0.9 | 0.4 | _ |

| Symbol/ | Conditions | Tra | nsceive Grade | r Speed 1 | Trai | nsceive Grade | r Speed 2 | Trar | isceive Grade | r Speed 3 | Unit |
|---|--|-----|------------------|--------------|------|------------------|--------------|------|------------------|--------------------------|------|
| Description | | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | |
| | DC Gain Setting = 0 | | 0 | _ | _ | 0 | | _ | 0 | — | dB |
| | DC Gain Setting = 1 | _ | 2 | _ | — | 2 | _ | _ | 2 | _ | dB |
| Programmable DC gain | DC Gain Setting = 2 | _ | 4 | _ | _ | 4 | _ | _ | 4 | _ | dB |
| | DC Gain Setting = 3 | _ | 6 | _ | _ | 6 | _ | _ | 6 | _ | dB |
| | DC Gain Setting = 4 | _ | 8 | _ | _ | 8 | _ | _ | 8 | — | dB |
| Transmitter | | | | | | | | | | | |
| Supported I/O Standards | _ | | | | - | I.4-V ar | nd 1.5-V PC | ML | | | |
| Data rate (Standard PCS) | _ | 600 | _ | 12200 | 600 | _ | 12200 | 600 | _ | 8500/ 10312.5 (24) | Mbps |
| Data rate (10G PCS) | _ | 600 | _ | 14100 | 600 | | 12500 | 600 | | 8500/ 10312.5 (24) | Mbps |
| | 85-Ω setting | | 85 ± 20% | _ | _ | 85 ± 20% | | _ | 85 ± 20% | _ | Ω |
| Differential on- | 100-Ω setting | _ | 100 ± 20% | _ | _ | 100 ± 20% | _ | _ | 100 ± 20% | _ | Ω |
| chip termination resistors | 120-Ω setting | _ | 120 ± 20% | | | 120 ± 20% | | _ | 120 ± 20% | | Ω |
| | 150-Ω setting | | 150 ± 20% | | | 150 ± 20% | | | 150 ± 20% | | Ω |
| V _{OCM} (AC coupled) | 0.65-V setting | | 650 | | _ | 650 | | _ | 650 | _ | mV |
| V _{OCM} (DC coupled) | _ | | 650 | | _ | 650 | | _ | 650 | _ | mV |
| Rise time (7) | 20% to 80% | 30 | | 160 | 30 | | 160 | 30 | | 160 | ps |
| Fall time ⁽⁷⁾ | 80% to 20% | 30 | | 160 | 30 | | 160 | 30 | | 160 | ps |
| Intra-differential pair skew | Tx V _{CM} = 0.5 V and slew rate of 15 ps | | | 15 | | | 15 | | | 15 | ps |
| Intra-transceiver block transmitter channel-to- channel skew | x6 PMA bonded mode | | | 120 | | | 120 | | | 120 | ps |

Table 23. Transceiver Specifications for Stratix V GX and GS Devices ⁽¹⁾ (Part 5 of 7)

| Symbol/ Description | Conditions | Trai | nsceive Grade | r Speed 1 | Trar | isceive Grade | r Speed 2 | Tran | isceive Grade | r Speed 3 | Unit |
|----------------------------|------------|------|------------------|--------------|------|------------------|--------------|------|------------------|--------------|------|
| Description | | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | |
| t _{pll_lock} (16) | _ | | | 10 | | — | 10 | | | 10 | μs |

Table 23. Transceiver Specifications for Stratix V GX and GS Devices ⁽¹⁾ (Part 7 of 7)

Notes to Table 23:

(2) The reference clock common mode voltage is equal to the V_{CCR_GXB} power supply level.

(3) This supply must be connected to 1.0 V if the transceiver is configured at a data rate > 6.5 Gbps, and to 1.05 V if configured at a data rate > 10.3 Gbps when DFE is used. For data rates up to 6.5 Gbps, you can connect this supply to 0.85 V.

- (4) This supply follows VCCR_GXB.
- (5) The device cannot tolerate prolonged operation at this absolute maximum.
- (6) The differential eye opening specification at the receiver input pins assumes that **Receiver Equalization** is disabled. If you enable **Receiver Equalization**, the receiver circuitry can tolerate a lower minimum eye opening, depending on the equalization level.
- (7) The Quartus II software automatically selects the appropriate slew rate depending on the configured data rate or functional mode.
- (8) The input reference clock frequency options depend on the data rate and the device speed grade.
- (9) The line data rate may be limited by PCS-FPGA interface speed grade.
- (10) Refer to Figure 1 for the GX channel AC gain curves. The total effective AC gain is the AC gain minus the DC gain.
- (11) t_{LTR} is the time required for the receive CDR to lock to the input reference clock frequency after coming out of reset.
- (12) t_{LTD} is time required for the receiver CDR to start recovering valid data after the rx_is_lockedtodata signal goes high.
- (13) t_{LTD_manual} is the time required for the receiver CDR to start recovering valid data after the rx_is_lockedtodata signal goes high when the CDR is functioning in the manual mode.
- (14) $t_{LTR_LTD_manual}$ is the time the receiver CDR must be kept in lock to reference (LTR) mode after the rx_is_lockedtoref signal goes high when the CDR is functioning in the manual mode.
- (15) $t_{pll_powerdown}$ is the PLL powerdown minimum pulse width.
- (16) t_{pll lock} is the time required for the transmitter CMU/ATX PLL to lock to the input reference clock frequency after coming out of reset.
- (17) To calculate the REFCLK rms phase jitter requirement for PCIe at reference clock frequencies other than 100 MHz, use the following formula: REFCLK rms phase jitter at f(MHz) = REFCLK rms phase jitter at 100 MHz × 100/f.
- (18) The maximum peak to peak differential input voltage V_{ID} after device configuration is equal to 4 × (absolute V_{MAX} for receiver pin V_{ICM}).
- (19) For ES devices, R_{BEF} is 2000 $\Omega \pm 1\%$.
- (20) To calculate the REFCLK phase noise requirement at frequencies other than 622 MHz, use the following formula: REFCLK phase noise at f(MHz) = REFCLK phase noise at 622 MHz + 20*log(f/622).
- (21) SFP/+ optical modules require the host interface to have RD+/- differentially terminated with 100 Ω. The internal OCT feature is available after the Stratix V FPGA configuration is completed. Altera recommends that FPGA configuration is completed before inserting the optical module. Otherwise, minimize unnecessary removal and insertion with unconfigured devices.
- (22) Refer to Figure 2.
- (23) For oversampling designs to support data rates less than the minimum specification, the CDR needs to be in LTR mode only.
- (24) I3YY devices can achieve data rates up to 10.3125 Gbps.
- (25) When you use fPLL as a TXPLL of the transceiver.
- (26) REFCLK performance requires to meet transmitter REFCLK phase noise specification.
- (27) Minimum eye opening of 85 mV is only for the unstressed input eye condition.

⁽¹⁾ Speed grades shown in Table 23 refer to the PMA Speed Grade in the device ordering code. The maximum data rate could be restricted by the Core/PCS speed grade. Contact your Altera Sales Representative for the maximum data rate specifications in each speed grade combination offered. For more information about device ordering codes, refer to the Stratix V Device Overview.

| Mada (2) | Transceiver | PMA Width | 20 | 20 | 16 | 16 | 10 | 10 | 8 | 8 |
|---------------------|-------------|--|---------|---------|---------|---------|-----|-----|------|------|
| Mode ⁽²⁾ | Speed Grade | PCS/Core Width | 40 | 20 | 32 | 16 | 20 | 10 | 16 | 8 |
| | 1 | C1, C2, C2L, I2, I2L core speed grade | 12.2 | 11.4 | 9.76 | 9.12 | 6.5 | 5.8 | 5.2 | 4.72 |
| | 2 | C1, C2, C2L, I2, I2L core speed grade | 12.2 | 11.4 | 9.76 | 9.12 | 6.5 | 5.8 | 5.2 | 4.72 |
| | 2 | C3, I3, I3L core speed grade | 9.8 | 9.0 | 7.84 | 7.2 | 5.3 | 4.7 | 4.24 | 3.76 |
| FIFO | | C1, C2, C2L, I2, I2L core speed grade | 8.5 | 8.5 | 8.5 | 8.5 | 6.5 | 5.8 | 5.2 | 4.72 |
| | 3 | I3YY core speed grade | 10.3125 | 10.3125 | 7.84 | 7.2 | 5.3 | 4.7 | 4.24 | 3.76 |
| | 5 | C3, I3, I3L core speed grade | 8.5 | 8.5 | 7.84 | 7.2 | 5.3 | 4.7 | 4.24 | 3.76 |
| | | C4, I4 core speed grade | 8.5 | 8.2 | 7.04 | 6.56 | 4.8 | 4.2 | 3.84 | 3.44 |
| | 1 | C1, C2, C2L, I2, I2L core speed grade | 12.2 | 11.4 | 9.76 | 9.12 | 6.1 | 5.7 | 4.88 | 4.56 |
| | 2 | C1, C2, C2L, I2, I2L core speed grade | 12.2 | 11.4 | 9.76 | 9.12 | 6.1 | 5.7 | 4.88 | 4.56 |
| | 2 | C3, I3, I3L core speed grade | 9.8 | 9.0 | 7.92 | 7.2 | 4.9 | 4.5 | 3.96 | 3.6 |
| Register | | C1, C2, C2L, I2, I2L core speed grade | 10.3125 | 10.3125 | 10.3125 | 10.3125 | 6.1 | 5.7 | 4.88 | 4.56 |
| | 3 | I3YY core speed grade | 10.3125 | 10.3125 | 7.92 | 7.2 | 4.9 | 4.5 | 3.96 | 3.6 |
| | 0 | C3, I3, I3L core speed grade | 8.5 | 8.5 | 7.92 | 7.2 | 4.9 | 4.5 | 3.96 | 3.6 |
| | | C4, I4 core speed grade | 8.5 | 8.2 | 7.04 | 6.56 | 4.4 | 4.1 | 3.52 | 3.28 |

Table 25 shows the approximate maximum data rate using the standard PCS.

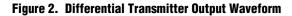
Table 25. Stratix V Standard PCS Approximate Maximum Date Rate (1), (3)

Notes to Table 25:

(1) The maximum data rate is in Gbps.

(2) The Phase Compensation FIFO can be configured in FIFO mode or register mode. In the FIFO mode, the pointers are not fixed, and the latency can vary. In the register mode the pointers are fixed for low latency.

(3) The maximum data rate is also constrained by the transceiver speed grade. Refer to Table 1 for the transceiver speed grade.



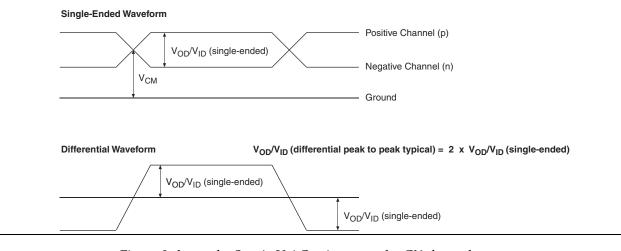


Figure 3 shows the Stratix V AC gain curves for GX channels.

Figure 3. AC Gain Curves for GX Channels (full bandwidth)

Stratix V GT devices contain both GX and GT channels. All transceiver specifications for the GX channels not listed in Table 28 are the same as those listed in Table 23.

Table 28 lists the Stratix V GT transceiver specifications.

| Table 28. Transceiver Specifications for Stratix V GT Devices (Part 4 of 5) ⁽¹⁾ |
|--|
|--|

| Symbol/ | Conditions | | Transceive peed Grade | | | Fransceive Deed Grade | | Unit |
|--|--|--------|--------------------------|--------------------------------|--------|--------------------------|--------------------------------|------|
| Description | | Min | Тур | Max | Min | Тур | Max | |
| Data rate | GT channels | 19,600 | | 28,050 | 19,600 | | 25,780 | Mbps |
| Differential on-chip | GT channels | | 100 | _ | | 100 | | Ω |
| termination resistors | GX channels | | 1 | 1 | (8) | | 11 | |
| | GT channels | | 500 | _ | | 500 | — | mV |
| V_{OCM} (AC coupled) | GX channels | | 1 | 1 | (8) | | 11 | |
| Dies/Fall times | GT channels | _ | 15 | _ | | 15 | — | ps |
| Rise/Fall time | GX channels | | | | (8) | | 1 | |
| Intra-differential pair skew | GX channels | | | | (8) | | | |
| Intra-transceiver block transmitter channel-to- channel skew | GX channels | | | | (8) | | | |
| Inter-transceiver block transmitter channel-to- channel skew | GX channels | | | | (8) | | | |
| CMU PLL | · · · · · · | | | | | | | |
| Supported Data Range | — | 600 | — | 12500 | 600 | — | 8500 | Mbps |
| t _{pll_powerdown} (13) | — | 1 | — | — | 1 | _ | — | μs |
| t _{pll_lock} ⁽¹⁴⁾ | — | _ | — | 10 | _ | _ | 10 | μs |
| ATX PLL | | | | | | | | |
| | VCO post- divider L=2 | 8000 | _ | 12500 | 8000 | _ | 8500 | Mbps |
| | L=4 | 4000 | — | 6600 | 4000 | _ | 6600 | Mbps |
| Supported Data Rate | L=8 | 2000 | — | 3300 | 2000 | - | 3300 | Mbps |
| Range for GX Channels | L=8, Local/Central Clock Divider =2 | 1000 | _ | 1762.5 | 1000 | _ | 1762.5 | Mbps |
| Supported Data Rate Range for GT Channels | VCO post- divider L=2 | 9800 | _ | 14025 | 9800 | _ | 12890 | Mbps |
| t _{pll_powerdown} ⁽¹³⁾ | — | 1 | — | — | 1 | — | — | μs |
| t _{pll_lock} ⁽¹⁴⁾ | — | | — | 10 | — | — | 10 | μs |
| fPLL | | | | | | | · · | |
| Supported Data Range | _ | 600 | | 3250/ 3.125 ⁽²³⁾ | 600 | _ | 3250/ 3.125 ⁽²³⁾ | Mbps |
| t _{pll_powerdown} (13) | | 1 | _ | | 1 | | | μs |

Figure 4 shows the differential transmitter output waveform.



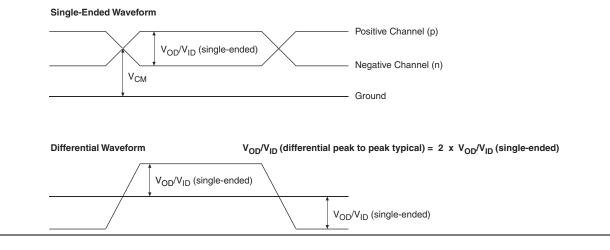


Figure 5 shows the Stratix V AC gain curves for GT channels.

Figure 5. AC Gain Curves for GT Channels

- XFI
- ASI
- HiGig/HiGig+
- HiGig2/HiGig2+
- Serial Data Converter (SDC)
- GPON
- SDI
- SONET
- Fibre Channel (FC)
- PCIe
- QPI
- SFF-8431

Download the Stratix V Characterization Report Tool to view the characterization report summary for these protocols.

Core Performance Specifications

This section describes the clock tree, phase-locked loop (PLL), digital signal processing (DSP), memory blocks, configuration, and JTAG specifications.

Clock Tree Specifications

Table 30 lists the clock tree specifications for Stratix V devices.

Table 30. Clock Tree Performance for Stratix V Devices (1)

| | | Performance | | |
|------------------------------|-----------------------------|--------------------------|--------|------|
| Symbol | C1, C2, C2L, I2, and I2L | C3, I3, I3L, and I3YY | C4, I4 | Unit |
| Global and Regional Clock | 717 | 650 | 580 | MHz |
| Periphery Clock | 550 | 500 | 500 | MHz |

Note to Table 30:

(1) The Stratix V ES devices are limited to 600 MHz core clock tree performance.

| Mode | C1 | C2, C2L | 12, 12L | C3 | 13, 13L, 13YY | C4 | 14 | Unit | | |
|------------------------|-----|---------|---------|-----|------------------|-----|-----|------|--|--|
| Modes using Three DSPs | | | | | | | | | | |
| One complex 18 x 25 | 425 | 425 | 415 | 340 | 340 | 275 | 265 | MHz | | |
| Modes using Four DSPs | | | | | | | | | | |
| One complex 27 x 27 | 465 | 465 | 465 | 380 | 380 | 300 | 290 | MHz | | |

Table 32. Block Performance Specifications for Stratix V DSP Devices (Part 2 of 2)

Memory Block Specifications

Table 33 lists the Stratix V memory block specifications.

Table 33. Memory Block Performance Specifications for Stratix V Devices ^{(1), (2)} (Part 1 of 2)

| | Mode | Resources Used | | Performance | | | | | | | |
|--------|--|-----------------------|--------|-------------|------------|-----|-----|---------|---------------------|-----|------|
| Memory | | ALUTS | Memory | C1 | C2, C2L | C3 | C4 | 12, 12L | 13, 13L, 13YY | 14 | Unit |
| | Single port, all supported widths | 0 | 1 | 450 | 450 | 400 | 315 | 450 | 400 | 315 | MHz |
| MLAB | Simple dual-port, x32/x64 depth | 0 | 1 | 450 | 450 | 400 | 315 | 450 | 400 | 315 | MHz |
| IVILAD | Simple dual-port, x16 depth ⁽³⁾ | 0 | 1 | 675 | 675 | 533 | 400 | 675 | 533 | 400 | MHz |
| | ROM, all supported widths | 0 | 1 | 600 | 600 | 500 | 450 | 600 | 500 | 450 | MHz |

| 0h.a.l | Oanditiana | | C1 | | C2, | C2L, I | 2, I2L | C3, | 13, 131 | ., I 3YY | | C4,I | 4 | 11 |
|---|--|-----|-----|------|-----|--------|--------|-----|---------|-----------------|-----|------|------|--------|
| Symbol | Conditions | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Unit |
| Transmitter | • | | | | | | | | | | | | | • |
| | SERDES factor J = 3 to 10 (9), (11), (12), (13), (14), (15), (16) | (6) | _ | 1600 | (6) | _ | 1434 | (6) | _ | 1250 | (6) | _ | 1050 | Mbps |
| | $\begin{array}{c} \text{SERDES factor J} \\ \geq 4 \end{array}$ | | | | | | | | | | | | | |
| True Differential I/O Standards | LVDS TX with DPA ⁽¹²⁾ , ⁽¹⁴⁾ , ⁽¹⁵⁾ , ⁽¹⁶⁾ | (6) | | 1600 | (6) | _ | 1600 | (6) | _ | 1600 | (6) | _ | 1250 | Mbps |
| - f _{HSDR} (data rate) | SERDES factor J = 2, | (6) | | (7) | (6) | | (7) | (6) | | (7) | (6) | | (7) | Mbps |
| | uses DDR Registers | (-) | | (1) | (-) | | (1) | (-) | | (*) | (") | | (*) | INIDA2 |
| | SERDES factor J = 1, uses SDR Register | (6) | _ | (7) | (6) | _ | (7) | (6) | _ | (7) | (6) | _ | (7) | Mbps |
| Emulated Differential I/O Standards with Three External Output Resistor Networks - f _{HSDR} (data rate) ⁽¹⁰⁾ | SERDES factor J = 4 to 10 $(^{17})$ | (6) | | 1100 | (6) | | 1100 | (6) | | 840 | (6) | | 840 | Mbps |
| t _{x Jitter} - True Differential | Total Jitter for Data Rate 600 Mbps - 1.25 Gbps | _ | _ | 160 | _ | _ | 160 | | | 160 | _ | | 160 | ps |
| I/O Standards | Total Jitter for Data Rate < 600 Mbps | _ | _ | 0.1 | _ | _ | 0.1 | _ | _ | 0.1 | _ | _ | 0.1 | UI |
| t _{x Jitter} - Emulated Differential I/O Standards | Total Jitter for Data Rate 600 Mbps - 1.25 Gbps | _ | _ | 300 | _ | _ | 300 | _ | _ | 300 | _ | _ | 325 | ps |
| with Three External Output Resistor Network | Total Jitter for Data Rate < 600 Mbps | _ | | 0.2 | _ | _ | 0.2 | _ | _ | 0.2 | _ | | 0.25 | UI |

Table 36. High-Speed I/O Specifications for Stratix V Devices (1), (2) (Part 2 of 4)

| Gumbal | Conditions | | C1 | | C2, | C2L, I | 2, I2L | C3, | 13, I3L | ., I 3 YY | | C4,I | 4 | 11 |
|----------------------------------|--|-----|-----|-----------|-----|--------|-----------|-----|---------|------------------|-----|------|-----------|----------|
| Symbol | Conultions | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Unit |
| | SERDES factor J = 3 to 10 | (6) | _ | (8) | (6) | _ | (8) | (6) | | (8) | (6) | | (8) | Mbps |
| f _{HSDR} (data rate) | SERDES factor J = 2, uses DDR Registers | (6) | | (7) | (6) | _ | (7) | (6) | | (7) | (6) | | (7) | Mbps |
| | SERDES factor J = 1, uses SDR Register | (6) | _ | (7) | (6) | _ | (7) | (6) | | (7) | (6) | | (7) | Mbps |
| DPA Mode | | | | | | | | | | | | | | |
| DPA run length | — | | | 1000 0 | | _ | 1000 0 | | _ | 1000 0 | | _ | 1000 0 | UI |
| Soft CDR mode |) | | | | | | | | | | | | | |
| Soft-CDR PPM tolerance | _ | _ | _ | 300 | _ | — | 300 | _ | | 300 | _ | | 300 | ± PPM |
| Non DPA Mode | • | • | | - | | - | | • | | - | | | - | - |
| Sampling Window | _ | | | 300 | | | 300 | | | 300 | | | 300 | ps |

Table 36. High-Speed I/O Specifications for Stratix V Devices ^{(1), (2)} (Part 4 of 4)

Notes to Table 36:

(1) When J = 3 to 10, use the serializer/deserializer (SERDES) block.

(2) When J = 1 or 2, bypass the SERDES block.

(3) This only applies to DPA and soft-CDR modes.

(4) Clock Boost Factor (W) is the ratio between the input data rate to the input clock rate.

(5) This is achieved by using the **LVDS** clock network.

(6) The minimum specification depends on the clock source (for example, the PLL and clock pin) and the clock routing resource (global, regional, or local) that you use. The I/O differential buffer and input register do not have a minimum toggle rate.

(7) The maximum ideal frequency is the SERDES factor (J) x the PLL maximum output frequency (fOUT) provided you can close the design timing and the signal integrity simulation is clean.

(8) You can estimate the achievable maximum data rate for non-DPA mode by performing link timing closure analysis. You must consider the board skew margin, transmitter delay margin, and receiver sampling margin to determine the maximum data rate supported.

(9) If the receiver with DPA enabled and transmitter are using shared PLLs, the minimum data rate is 150 Mbps.

(10) You must calculate the leftover timing margin in the receiver by performing link timing closure analysis. You must consider the board skew margin, transmitter channel-to-channel skew, and receiver sampling margin to determine leftover timing margin.

(11) The F_{MAX} specification is based on the fast clock used for serial data. The interface F_{MAX} is also dependent on the parallel clock domain which is design-dependent and requires timing analysis.

(12) Stratix V RX LVDS will need DPA. For Stratix V TX LVDS, the receiver side component must have DPA.

(13) Stratix V LVDS serialization and de-serialization factor needs to be x4 and above.

(14) Requires package skew compensation with PCB trace length.

(15) Do not mix single-ended I/O buffer within LVDS I/O bank.

(16) Chip-to-chip communication only with a maximum load of 5 pF.

(17) When using True LVDS RX channels for emulated LVDS TX channel, only serialization factors 1 and 2 are supported.

| | Member Code | | Active Serial (1) |) | Fast Passive Parallel ⁽²⁾ | | | | |
|---------|----------------|-------|-------------------|------------------------|--------------------------------------|------------|------------------------|--|--|
| Variant | | Width | DCLK (MHz) | Min Config Time (s) | Width | DCLK (MHz) | Min Config Time (s) | | |
| | D3 | 4 | 100 | 0.344 | 32 | 100 | 0.043 | | |
| | D4 | 4 | 100 | 0.534 | 32 | 100 | 0.067 | | |
| GS | D4 | 4 | 100 | 0.344 | 32 | 100 | 0.043 | | |
| 65 | D5 | 4 | 100 | 0.534 | 32 | 100 | 0.067 | | |
| | D6 | 4 | 100 | 0.741 | 32 | 100 | 0.093 | | |
| | D8 | 4 | 100 | 0.741 | 32 | 100 | 0.093 | | |
| Е | E9 | 4 | 100 | 0.857 | 32 | 100 | 0.107 | | |
| | EB | 4 | 100 | 0.857 | 32 | 100 | 0.107 | | |

Table 48. Minimum Configuration Time Estimation for Stratix V Devices

Notes to Table 48:

(1) DCLK frequency of 100 MHz using external CLKUSR.

(2) Max FPGA FPP bandwidth may exceed bandwidth available from some external storage or control logic.

Fast Passive Parallel Configuration Timing

This section describes the fast passive parallel (FPP) configuration timing parameters for Stratix V devices.

DCLK-to-DATA[] Ratio for FPP Configuration

FPP configuration requires a different DCLK-to-DATA[]ratio when you enable the design security, decompression, or both features. Table 49 lists the DCLK-to-DATA[]ratio for each combination.

| Configuration Scheme | Decompression | Design Security | DCLK-to-DATA[] Ratio |
|-------------------------|---------------|-----------------|-------------------------|
| | Disabled | Disabled | 1 |
| FPP ×8 | Disabled | Enabled | 1 |
| FFF X0 | Enabled | Disabled | 2 |
| | Enabled | Enabled | 2 |
| | Disabled | Disabled | 1 |
| FPP ×16 | Disabled | Enabled | 2 |
| | Enabled | Disabled | 4 |
| | Enabled | Enabled | 4 |

 Table 49. DCLK-to-DATA[] Ratio ⁽¹⁾ (Part 1 of 2)

Table 50 lists the timing parameters for Stratix V devices for FPP configuration when the DCLK-to-DATA[] ratio is 1.

Table 50. FPP Timing Parameters for Stratix V Devices (1)

| Symbol | Parameter | Minimum | Maximum | Units |
|-----------------------------------|---|--|----------------------|-------|
| t _{CF2CD} | nCONFIG low to CONF_DONE low | — | 600 | ns |
| t _{CF2ST0} | nCONFIG low to nSTATUS low | — | 600 | ns |
| t _{CFG} | nCONFIG low pulse width | 2 | — | μS |
| t _{status} | nSTATUS low pulse width | 268 | 1,506 ⁽²⁾ | μS |
| t _{CF2ST1} | nCONFIG high to nSTATUS high | — | 1,506 ⁽³⁾ | μS |
| t _{CF2CK} (6) | nCONFIG high to first rising edge on DCLK | 1,506 | _ | μS |
| t _{ST2CK} ⁽⁶⁾ | nSTATUS high to first rising edge of DCLK | 2 | _ | μS |
| t _{DSU} | DATA [] setup time before rising edge on DCLK | 5.5 | _ | ns |
| t _{DH} | DATA [] hold time after rising edge on DCLK | 0 | _ | ns |
| t _{CH} | DCLK high time | $0.45\times1/f_{MAX}$ | — | S |
| t _{CL} | DCLK low time | $0.45\times1/f_{MAX}$ | — | S |
| t _{CLK} | DCLK period | 1/f _{MAX} | _ | S |
| f | DCLK frequency (FPP ×8/×16) | — | 125 | MHz |
| f _{MAX} | DCLK frequency (FPP ×32) | — | 100 | MHz |
| t _{CD2UM} | CONF_DONE high to user mode ⁽⁴⁾ | 175 | 437 | μS |
| + | CONTRACT high to an union analysis | 4 × maximum | | |
| t _{CD2CU} | CONF_DONE high to CLKUSR enabled | DCLK period | — | |
| t _{CD2UMC} | CONF_DONE high to user mode with CLKUSR option on | $\begin{array}{c} t_{\text{CD2CU}} + \\ (8576 \times \text{CLKUSR} \\ \text{period}) \ ^{(5)} \end{array}$ | _ | _ |

Notes to Table 50:

(1) Use these timing parameters when the decompression and design security features are disabled.

(2) This value is applicable if you do not delay configuration by extending the nCONFIG or nSTATUS low pulse width.

(3) This value is applicable if you do not delay configuration by externally holding the nSTATUS low.

- (4) The minimum and maximum numbers apply only if you chose the internal oscillator as the clock source for initializing the device.
- (5) To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on these pins, refer to the Initialization section of the "Configuration, Design Security, and Remote System Upgrades in Stratix V Devices" chapter.
- (6) If nSTATUS is monitored, follow the t_{ST2CK} specification. If nSTATUS is not monitored, follow the t_{CF2CK} specification.

FPP Configuration Timing when DCLK-to-DATA [] > 1

Figure 13 shows the timing waveform for FPP configuration when using a MAX II device, MAX V device, or microprocessor as an external host. This waveform shows timing when the DCLK-to-DATA [] ratio is more than 1.

Remote System Upgrades

Table 56 lists the timing parameter specifications for the remote system upgrade circuitry.

| Table 56. Remote System Upgrade Circuitry Timing Specifications |
|---|
|---|

| Parameter | Minimum | Maximum | Unit |
|---|---------|---------|------|
| t _{RU_nCONFIG} ⁽¹⁾ | 250 | — | ns |
| t _{RU_nRSTIMER} ⁽²⁾ | 250 | — | ns |

Notes to Table 56:

- (1) This is equivalent to strobing the reconfiguration input of the ALTREMOTE_UPDATE megafunction high for the minimum timing specification. For more information, refer to the Remote System Upgrade State Machine section of the "Configuration, Design Security, and Remote System Upgrades in Stratix V Devices" chapter.
- (2) This is equivalent to strobing the reset_timer input of the ALTREMOTE_UPDATE megafunction high for the minimum timing specification. For more information, refer to the User Watchdog Timer section of the "Configuration, Design Security, and Remote System Upgrades in Stratix V Devices" chapter.

User Watchdog Internal Circuitry Timing Specification

Table 57 lists the operating range of the 12.5-MHz internal oscillator.

Table 57. 12.5-MHz Internal Oscillator Specifications

| Minimum | Typical | Maximum | Units |
|---------|---------|---------|-------|
| 5.3 | 7.9 | 12.5 | MHz |

I/O Timing

Altera offers two ways to determine I/O timing—the Excel-based I/O Timing and the Quartus II Timing Analyzer.

Excel-based I/O timing provides pin timing performance for each device density and speed grade. The data is typically used prior to designing the FPGA to get an estimate of the timing budget as part of the link timing analysis. The Quartus II Timing Analyzer provides a more accurate and precise I/O timing data based on the specifics of the design after you complete place-and-route.

 You can download the Excel-based I/O Timing spreadsheet from the Stratix V Devices Documentation web page.

Programmable IOE Delay

Table 58 lists the Stratix V IOE programmable delay settings.

Table 58. IOE Programmable Delay for Stratix V Devices (Part 1 of 2)

| Parameter | Available | Min | Fast Model | | Slow Model | | | | | | | |
|-----------|--------------|------------|------------|-------|------------|-------|-------|-------|-------------|-------|-------|----|
| (1) | Settings (2) | Industrial | Commercial | C1 | C2 | C3 | C4 | 12 | 13, 13YY | 14 | Unit | |
| D1 | 64 | 0 | 0.464 | 0.493 | 0.838 | 0.838 | 0.924 | 1.011 | 0.844 | 0.921 | 1.006 | ns |
| D2 | 32 | 0 | 0.230 | 0.244 | 0.415 | 0.415 | 0.459 | 0.503 | 0.417 | 0.456 | 0.500 | ns |